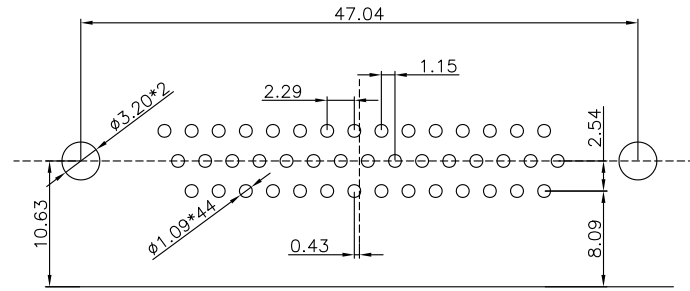
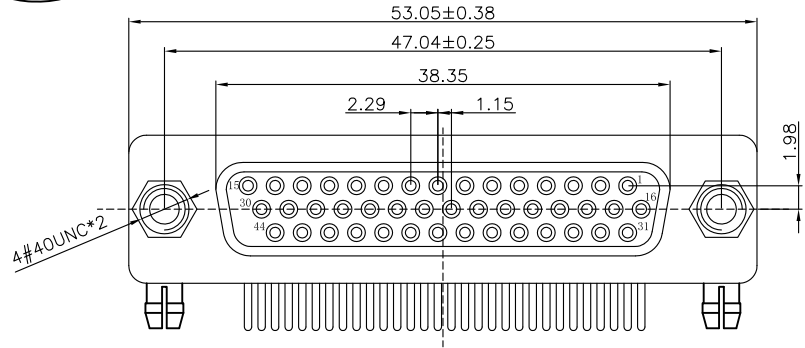
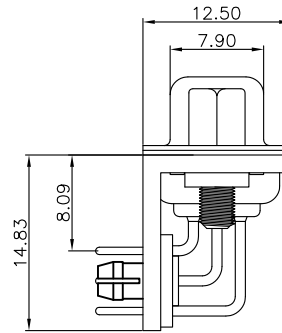
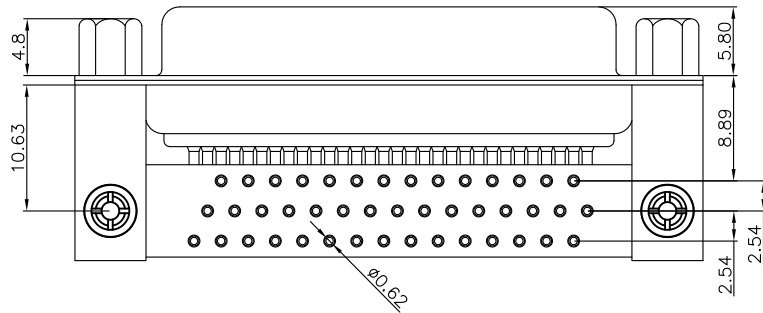


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements

RoHS



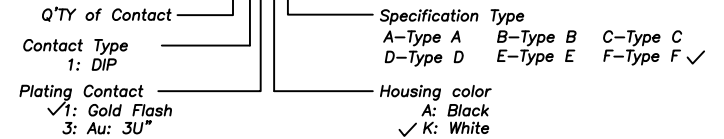
P.C.B LAYOUT



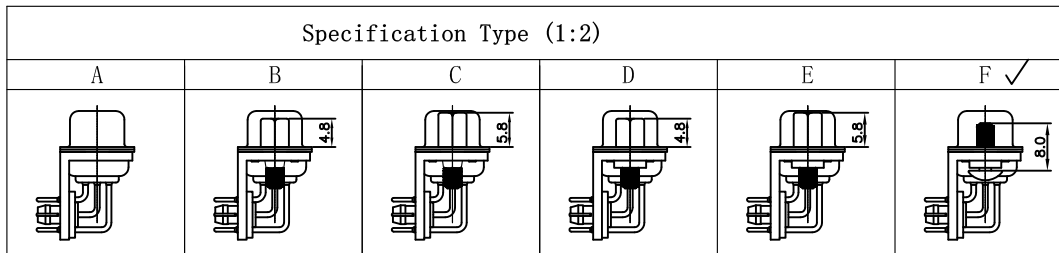
NOTE

- 1.ELECTRICAL:
 - 1-1 INSULATOR RESISTANCE: 1000MEG OHMS MIN AT 500V DC.
 - 1-2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC R.M.S
 - 1-3 RATED VOLTAGE: 300V AC Min
 - 1-4 CURRENT RATING: 3A.
 - 1-5 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
- 2.ENVIRONMENTAL
 - TEMPERATURE RANGE:-55°C TO + 105°C.
- 3.SHELL SALT SPRAY: 48H;

P / N:WLDBF9-441XXX233



Specification Type (1:2)



Item	Name	Material	Surface Plating
1	Housing	PBT	White
2	Contact	Copper alloy	Gold allover
3	Shell	Spcc-sd	Nickel Plating
4	PCB-Holding	Spcc-sd	Nickel Plating
5	PCB-Lock	Copper alloy	Tin Plating
6	Rivet	Copper alloy	Nickel Plating
7	Screw	Copper alloy	Nickel Plating
8	PCB-Board	High Temp plastic	Nature

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:
AO	NEW RELEASE	22.03.19		LINEAR	1:1	Wang_jr	22.03.19	WLDBF9-441XXX233	ENDE05
				ANGLES					
				0.0±0.35	X'REF±6°				
				0.00±0.25	X'±3°				
			UNIT:mm	0.00±0.10		X'X' ±2°			
			SIZE: A4						



WanLian Technology Co., Ltd
REV: A0 SHEET: 1/1